

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	semiconductor adj3 die and package and mounting and circuit adj3 pattern and terminal and encapsulating and ablating and via	US-PGPUB; USPAT	OR	ON	2006/08/07 10:07
L2	1	semiconductor adj3 die and mounting and circuit adj3 pattern and encapsulating and ablating and via	US-PGPUB; USPAT	OR	ON	2006/08/07 10:07
L5	1	semiconductor adj3 die and mounting and circuit adj3 pattern and encapsulating and ablating	US-PGPUB; USPAT	OR	ON	2006/08/07 10:10